AMENDMENTS TO THE CLAIMS (IN REVISED FORMAT COMPLIANT WITH THE PROPOSED REVISION TO 37 CFR 1.121)

1. (CURRENTLY AMENDED) An apparatus comprising:

a first device comprising (i) a first gate configured to receive an input voltage ranging from greater than up to twice a first supply voltage with respect to a second supply voltage to at least a said second supply voltage, (ii) a first drain configured to receive said first supply voltage, and (iii) a first source coupled to a first output; and

to said first source and (ii) a second side configured to receive

to said second supply voltage, wherein said apparatus is arranged such
that a maximum voltage drop across a gate oxide of said first blue 2 blue device does not exceed a difference between said first supply voltage and said second supply voltage.

2. (CANCELLED)

3. (PREVIOUSLY AMENDED) The apparatus according to claim 1, wherein said first device is configured in a source-follow configuration.

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- 4, (PREVIOUSLY AMENDED) The apparatus according to claim 1, wherein said first device comprises an NMOS device.
- (PREVIOUSLY AMENDED) The apparatus according to 5. claim 1, wherein said first device comprises a native NMOS device.

6. (PREVIOUSLY CANCELLED)

- . 7. (PREVIOUSLY AMENDED) The apparatus according to claim 1, wherein said first device comprises a PMOS device.
- (PREVIOUSLY AMENDED) The apparatus according to 8. claim 1, wherein said first device comprises a native PMOS device.
- (ORIGINAL) The apparatus according to claim 1, wherein said first supply voltage comprises a ground voltage.
- 10. (ORIGINAL) The apparatus according to claim 1, wherein said second supply voltage comprises a ground voltage.
- 11. (CURRENTLY AMENDED) A method for implementing voltage protection comprising the steps of:

configuring a device to have (i) a gate for receiving an input voltage ranging from greater than up to twice a first supply

voltage with respect to a second supply voltage to at least a said second supply voltage, (ii) a drain for receiving said first supply voltage, and (iii) a source coupled to an output; and

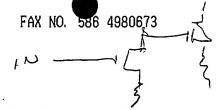
configuring a resistive element to have (i) a first side coupled to said source and (ii) a second side for receiving said second supply voltage, wherein said device and said resistive element are arranged such that a maximum voltage drop across a gate exide of said device does not exceed a difference between said first supply voltage and said second supply voltage.

12. (CANCELLED)

- 13. (ORIGINAL) The method according to claim 11, wherein said device is configured in a source-follow configuration.
- 14. (ORIGINAL) The method according to claim 11, wherein said device comprises an NMOS device.
- 15. (ORIGINAL) The method according to claim 11, wherein said device comprises a PMOS device.
- 16. (ORIGINAL) The method according to claim 11, wherein said device comprises a native NMOS device.

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17. (ORIGINAL) The mothod according to claim 11, wherein said device comprises a native PMOS device.

18. (PREVIOUSLY AMENDED) An apparatus comprising:

a first stage comprising (A) a first device comprising (i) a first gate configured to receive an input voltage ranging from greater than a first supply voltage to at least a second supply voltage, (ii) a first drain configured to receive said second supply voltage, and (iii) a first source coupled to a first output, and (B) a first resistive element having (i) a first side coupled to said first source and (ii) a second side configured to receive said first supply voltage; and

a second stage comprising (A) a second device comprising (i) a second gate coupled to said first output, (ii) a second drain configured to receive said first supply voltage, and (iii) a second source coupled to a second output, and (B) a second resistive element having (i) a first side coupled to said second source and (ii) a second side configured to receive said second supply voltage, wherein said apparatus is arranged such that a maximum voltage drop across a gate oxide of said first device does not exceed a difference between said first supply voltage and said second supply voltage.

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19. (PREVIOUSLY AMENDED) The apparatus according to claim 1, further comprising:

a second device comprising (i) a second gate configured to receive said input voltage, (ii) a second drain configured to receive said second supply voltage, and (iii) a second source coupled to a second output;

a second resistive element having (i) a first side coupled to said second source and (ii) a second side configured to receive said first supply voltage; and

a multiplexer configured to multiplex said first output and said second output to a third output.

(PREVIOUSLY AMENDED) An apparatus comprising: 20.

a first stage comprising (A) a first device comprising (i) a first gate configured to receive an input voltage ranging from greater than a first supply voltage to at least a second supply voltage, (ii) a first drain configured to receive said first supply voltage, and (iii) a first source coupled to an output, and (B) a first resistive element having (i) a first side coupled to said first source and (ii) a second side configured to receive said second supply voltage; and

a second stage comprising (A) a second device comprising (i) a second gate configured to receive said input voltage, (ii) a second drain configured to receive said second supply voltage, and

(iii) a second source coupled to said output, and (B) a second resistive element having a first side coupled to said second source and a second side configured to receive said first supply voltage, wherein said apparatus is arranged such that a maximum voltage drop across each gate oxide of said first device and said second device does not exceed a difference between said first supply voltage and said second supply voltage.